



Recommended P.C. Board Layout

NOTES:

Electrical Specifications:
 Contact Resistance: 50minliohms MAX
 Dielectric Wthstanding: Voltange 100VAC AT Sea Level
 Insulation Resistance: 100MΩ MIN

Material:

Housing :High Temperature: UL94V-0
 Contact:Copper Alloy
 Shell:Copper Alloy

PLATING:

Contact:Piated Gold in
 Mating Area;Tin On Solder Talls
 Nickel/Plating

202C-F B I 0-R03
 1 2 3 4

1.Type
 F:Female Type for PCB

2.Contact Plating
 B:30u”Gold Plating

3.Shell Plating
 T:Tin Plating

4.RoHS

| UNLESS OTHERWISE SPECIFIED TOLERANCE | | |
|--------------------------------------|----------|------------|
| ANGLES | ANG. | ±5° |
| LINEAR | 0. | ±0.3 |
| | 0.0 | ±0.25 |
| | 0.00 | ±0.20 |
| SCALE | AS SHOWN | UNIT: mm |
| DRAWN | Willis | 2012/08/03 |
| CHECKED | Angel | 2012/08/03 |
| APPROVED | Ken | 2012/08/03 |



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DRAWN NAME:
 Mini USB AB Receptacle SMD Type

PRODUCT NO. 202C-FBT0-R03

FILE NAME 202C-FBT0-R03_B_1

| REV. | DESCRIPTION | DATE | REV. | DESCRIPTION | DATE |
|------|-------------|------|------|-------------|------|
| 1 | | | 1 | | |
| 2 | | | 2 | | |
| 3 | | | 3 | | |
| 4 | | | 4 | | |
| 5 | | | 5 | | |
| 6 | | | 6 | | |
| 7 | | | 7 | | |



SIZE A4

REV. 1.0